## UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO.

: 6,930,756 B2

Page 1 of 1

DATED

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INVENTOR(S): Kotaro Akutsu et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

## Column 2,

Line 37, "electron-beams" should read -- electron beams --.

## Column 10,

Line 3, "process (chip" should read -- process (dicing and bonding) and packing process (chip --.

Signed and Sealed this

Tenth Day of January, 2006

JON W. DUDAS

Director of the United States Patent and Trademark Office